

CLAIMS

1. A method of providing at least part of a diaphragm and at least a part of a back-plate of a condenser microphone with a hydrophobic layer so as to avoid stiction between said
5 diaphragm and said back-plate, said method comprising the steps of
- providing a condenser microphone comprising a diaphragm and a back-plate, wherein an inner surface of said diaphragm forms a capacitor in combination with an inner surface of said back-plate, and
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 - providing the hydrophobic layer onto the inner surfaces of the diaphragm and the back-plate through a number of openings, said openings being in the back-plate, in the diaphragm and/or between the diaphragm and the back-plate.
- 15 2. A method according to claim 1, wherein at least the inner surfaces of the diaphragm and the back-plate are made from a hydrophilic material.
3. A method according to claim 1, wherein the step of providing the hydrophobic layer is performed by providing the hydrophobic layer through a number of openings, the smallest
20 dimension of each of said openings not exceeding 10 μm .
4. A method according to claim 3, wherein the step of providing the hydrophobic layer is performed by providing the hydrophobic layer through a number of openings, the smallest dimension of each of said openings not exceeding 5 μm .
- 25 5. A method according to claim 4, wherein the step of providing the hydrophobic layer is performed by providing the hydrophobic layer through a number of openings, the smallest dimension of each of said openings not exceeding 1 μm .
- 30 6. A method according to claim 5, wherein the step of providing the hydrophobic layer is performed by providing the hydrophobic layer through a number of openings, the smallest dimension of each of said openings not exceeding 0.5 μm .
7. A method according to claim 1, wherein the static distance between the diaphragm and
35 the back-plate is smaller than 10 μm .

8. A method according to claim 7, wherein the static distance between the diaphragm and the back-plate is smaller than 5 μm .

5 9. A method according to claim 8, wherein the static distance between the diaphragm and the back-plate is smaller than 1 μm .

10. A method according to claim 9, wherein the static distance between the diaphragm and the back-plate is smaller than 0.5 μm .

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11. A method according to claim 10, wherein the static distance between the diaphragm and the back-plate is smaller than 0.3 μm .

12. A method according to claim 1, wherein the step of providing the hydrophobic layer is
15 performed by chemical binding of the hydrophobic layer to poly-silicon, silicon-oxide, silicon nitride and/or silicon-rich silicon nitride surfaces, and forming hydrophobic chains from said hydrophobic layer, said hydrophobic chains pointing away from the surface to which the binding is formed.

20 13. A method according to claim 1, wherein the step of providing the hydrophobic layer comprises the steps of

- forming a molecule monolayer, and
- cross linking between molecules and multi binding to surfaces

25 14. A method according to claim 1, wherein the hydrophobic layer base material comprises an alkylsilane.

15. A method according to claim 1, wherein the hydrophobic layer base material comprises a perhaloalkylsilane.

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16. A method according to claim 1, further comprising the step of positioning at least part of the diaphragm and at least part of the back-plate in a liquid comprising a liquid phase of the hydrophobic layer base material to be provided on the inner surfaces.

17. A method according to claim 1, further comprising the step of positioning at least part of the diaphragm and at least part of the back-plate in a container comprising a gaseous phase of the hydrophobic layer base material to be provided on the inner surfaces.

5 18. A method according to claim 1, wherein the hydrophobic layer being provided has a contact angle for water being between 90° and 130° .

19. A method according to claim 18, wherein the hydrophobic layer being provided has a contact angle for water being between 100° and 110° .

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20. A method according to claim 1, wherein the hydrophobic layer being provided is stable at temperatures between -40°C and 130°C .

21. A method according to claim 20, wherein the hydrophobic layer being provided is
15 stable at temperatures between -30°C and 110°C .

22. A method according to claim 1, wherein the hydrophobic layer being provided is stable at temperatures up to at least 400°C for at least 5 minutes.

20 23. A condenser microphone comprising a diaphragm and a back-plate, wherein an inner surface of said diaphragm forms a capacitor in combination with an inner surface of said back-plate, said back-plate and/or said diaphragm is/are provided with a number of openings, and said inner surfaces being provided with a hydrophobic layer, and wherein the static distance between said diaphragm and said back-plate is smaller than $10\text{ }\mu\text{m}$.

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24. A condenser microphone according to claim 23, wherein at least the inner surfaces of the diaphragm and the back-plate are made from a hydrophilic material.

25. A condenser microphone according to claim 23, wherein the smallest dimension of
30 each of the openings does not exceed $10\text{ }\mu\text{m}$.

26. A condenser microphone according to claim 25, wherein the smallest dimension of each of the openings does not exceed $5\text{ }\mu\text{m}$.

27. A condenser microphone according to claim 26, wherein the smallest dimension of each of the openings does not exceed 1 μm .

28. A condenser microphone according to claim 27, wherein the smallest dimension of
5 each of the openings does not exceed 0.5 μm .

29. A condenser microphone according to claim 26, wherein the smallest dimension of each of the openings is approximately 3 μm .

10 30. A condenser microphone according to claim 23, wherein the hydrophobic layer base material comprises an alkylsilane.

31. A condenser microphone according to claim 23, wherein the hydrophobic layer base material comprises a perhaloalkylsilane.

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32. A condenser microphone according to claim 23, wherein the static distance between the diaphragm and the back-plate is smaller than 5 μm .

33. A condenser microphone according to claim 32, wherein the static distance between
20 the diaphragm and the back-plate is smaller than 1 μm .

34. A condenser microphone according to claim 33, wherein the static distance between the diaphragm and the back-plate is smaller than 0.5 μm .

25 35. A condenser microphone according to claim 34, wherein the static distance between the diaphragm and the back-plate is smaller than 0.3 μm .

36. A condenser microphone according to claim 33, wherein the static distance between the diaphragm and the back-plate is approximately 0.9 μm .

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37. A condenser microphone according to claim 23, wherein the hydrophobic layer has a contact angle for water being between 90° and 130°.

38. A condenser microphone according to claim 37, wherein the hydrophobic layer has a
35 contact angle for water being between 100° and 110°.

39. A condenser microphone according to claim 23, wherein the hydrophobic layer is stable at temperatures between -40°C and 130°C .

5 40. A condenser microphone according to claim 39, wherein the hydrophobic layer is stable at temperatures between -30°C and 110°C .

41. A condenser microphone according to claim 23, wherein the hydrophobic layer is stable at temperatures up to at least 400°C for at least 5 minutes.

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